

Issued: Sept. 2006 Revision 3: Nov. 2021, Page: 1	Two Component Sem	i-Flexible Epoxy Compo	und	
Product Description	EP 502MD/EPC 502MD is a two-component easy-to-use semi flexible epox compound for potting and encapsulating. EP 502MD designed for protectio electronic components and systems			
Features & Benefits	• Easy-to-use	• Semi-flexible		
	• Room temperature cured • Moderate viscosity			
	• Good mechanical properties			
Applications	Encapsulation and potting of electrical and electronic components.			
Typical Uncured Properties	Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.			
-	Base Resins	EP 502MD (A) EPC 502MD Fast(B)	Epoxy Resin Modified Polyamide	
	Appearance/Color	A B	Black Amber	
	Viscosity,	A	9000-13000	
	per ASTM-D-2196, mPa*s @25°C	B Mixed A+B	2000-4000 4000-6000	
	<b>Density</b> , g/cm <sup>3</sup>	А	1.16	
	@ 25°C	В	1.0	
	Mix Ratio (A:B)	By weight By volume	100:86 1:1	
Instructions for use:	Weigh required amount of resin EP 502MD and hardener EPC 502MD into a clean container in the recommended ratio. Blend thoroughly being			
	careful to scrape sides and bottom of the container for 3-4 minutes to ensure uniform mixture. To produce a void-free casting, the mixture should be deairing at 2-5mmHg for 5-7 minutes to remove trapped air.			
Cure Schedule:	Curing 16-24 hr @RT, or 3-4 hr @ RT+ 4 hr @60°C			

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## **EP 502MD/EPC 502MD**

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Mechanical		
	Color	black
	Gel-time @ 25°C, (100g), min	30
	<b>De-mold</b> @ 25°C, hr	24
	Final curing @ 25°C, days	7
	Hardness, Shore D (after 7 days)	78
	Tensile Strength, MPa	41
	<b>Tensile Elongation</b> (at max), %	4.2
	Heat Distortion Point, °C	35
	Service Temperature, °C	-40 to 90

Stir and allow content to cool to room temperature before use.Limitation of LiabilityExcept where prohibited by law, Polymer-G and seller will not be liable for<br/>any loss or damage arising from the Polymer-G product, whether direct,<br/>indirect, special, incidental or consequential, regardless of the legal theory<br/>asserted, including warranty, contract, negligence or strict liability.

have dissolved.